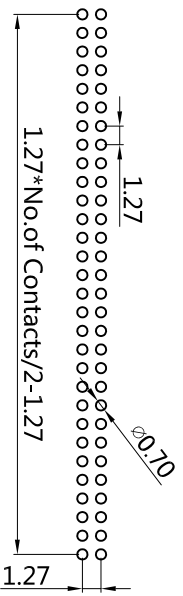
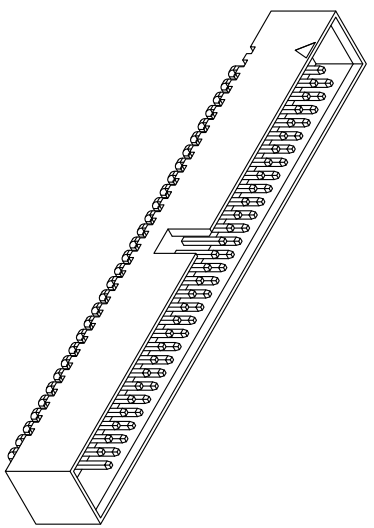
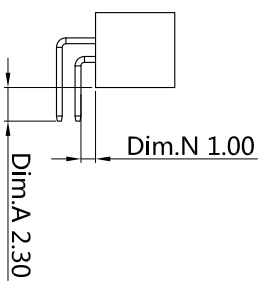
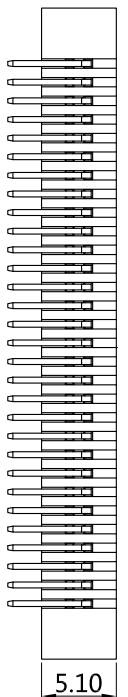
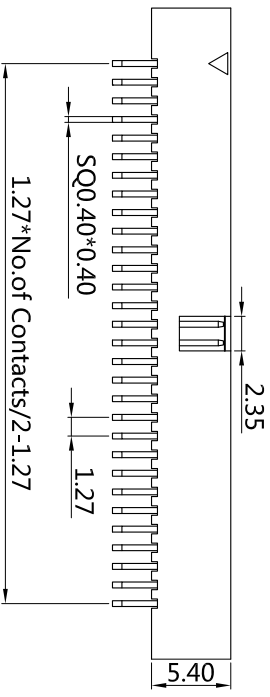
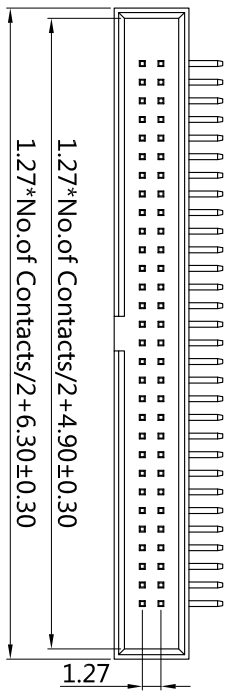
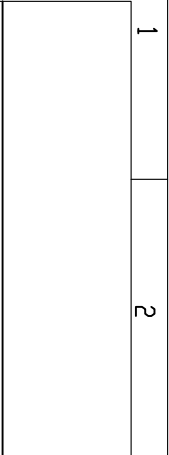


1 2 3 4 5 6 7 8



Recommended P.C. Board  
Hole Layout

Current Rating: 1 Amps  
 Insulator Resistance: 1000 Megohms min  
 Contact Resistance: 20m ohms max.  
 Dielectric Withstanding: AC 500V  
 Operating Temperature: -40° ~ +105° C  
 Max Processing Temp: 230° C for 60 seconds  
 260° C for 10 seconds  
 Contact Material: Brass  
 Insulator Material: Polyester, UL 94V-0  
 Finish: Gold Plated  
 Standard: Gold Flash all over

BH32 X - XX R0 BK X 000 X  
 I 1 2 3 4 5 6 7

1. Insulator Material: N=PA6T P=PA9T  
 2. Circuits: 06~60pin  
 3. Tail Style: S0=90°  
 4. Color: BK=Black
5. Contact Plated: T=Matte tin over nickel  
 W=Matte tin over nickel 150µ"  
 Y=Brighe tin over nickel  
 C=Gold flash  
 F=Gold flash, tin 50µ"  
 A=Gold 3µ"  
 C=Gold 0.8µ"
6. Special Options: I=Gold 1µ"  
 E=Gold 5µ", Ni 50 µ"  
 G=Gold 10µ"  
 J=Gold 10µ", Ni 50 µ"  
 L=Gold 15 µ"  
 M=Gold 15 µ", Ni 50 µ"  
 U=Gold 30 µ", Ni 50 µ"  
 V=Gold 30 µ", Ni 50 µ"  
 N=Gold flash, Ni
7. Packing: B=Tube  
 C=Tray  
 D=Box  
 E=Cap+tap&reel  
 N=Tap&reel



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 DONG GUAN ZHEN HENG ELECTRONICS CO., LTD

BOM 1: BH32P-60BKHC9  
 2: SQ0.4-8.3/10.8-X-C12  
 3:

PART NO.	BH32X-XXR0BKX000X	X	.XX	.XXX
DRAWING NO	ZS-00002-J	±0.30	±0.20	±0.1
DRAWN BY	Deng jin quan	EDITION: A1	ITEM: BH32	SCALE: 1:1
APPROVAL BY	Chen xiao quang	2022-11-09	2022-11-15	UNIT: M.M

F E D C B A